

DOCUMENT CHANGE REQUEST

140 DCR number Originator: S Thacker Changes required for: General Date: 2004/09/10 Date sent: 2004/09/10 Organisation: ESA/ESTEC Status: IMPLEMENTED Title: HCMOS 8-Bit Shift Registers with 3 State Output Registers, based on type 54HC595 Number: 9306/051 Issue: 2 Other documents affected: Page: See attached Markup Paragraph: See attached Markup Original wording: Proposed wording: 1) para 2.3.1, 2.3.2, 2.4, 2.5 Electrical measurements Tables: Correction of IOL & IOH conditions for VOL4, VOL5 & VOH4, VOH5 tests for output QH' by addition of VOL6, VOL7, VOH6, VOH7 - see attached mark-up for details. 2) In addition several editorial corrections have been included as detailed on the mark-up including: a) - para 1.4.2 Component type variants: delete "G8" terminal material & finish. b) - para 2.3.1 & 2.3.2 Electrical measurements Tables: Insert VIL & VIH definitions in timing parameter tests. c) - para 2.3.3 Note 1: expand note to include definition of inputs & outputs not under test. d) - para 2.3.3 Note 6: add "with 0 failures permitted" e) - para 2.3.3 Note 7 replace "clock" with actual inputs tested "SRCLK" & "RCLK". f) - other minor editorial amendments have been included as per the mark-up. Justification: 1) Correction of a technical error in the specification.

2) Editorial changes have been made for the purposes of clarification and consistency of content of this specification to

others in the 54HC and 4000B series of ESCC specifications.

Attachments:
9306051_DCR_PAGES.pdf, 140att1.pdf, null
Modifications:
N/A
Approval signature:
Jl. Kaile
Date signed:
2004-09-10

Marker Per Der. Sithacker.



Pages 1 to 28

8-BIT SHIFT REGISTER WITH 3-STATE OUTPUT REGISTER

BASED ON TYPE 54HC595

ESCC Detail Specification No. 9306/051

3	September 2004
Issue 2	October 2003







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2004

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ISSUE 2

DOCUMENTATION CHANGE NOTICE

(Refer to https://escies.org for ESCC DCR content)

DCR No.	CHANGE DESCRIPTION
198	Specification upissued to incorporate editorial and technical changes per DCR.

per allocated



1. GENERAL

1.1 SCOPE

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type variants and/or the range of components specified below. It supplements the requirements of, and shall be read in conjunction with, the ESCC Generic Specification listed under Applicable Documents.

1.2 APPLICABLE DOCUMENTS

The following documents form part of this specification and shall be read in conjunction with it:

- (a) ESCC Generic Specification No. 9000.
- (b) MIL-STD-883, Test Methods and Procedures for Microelectronics.

1.3 <u>TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS</u>

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Basic Specification No. 21300 shall apply.

1.4 THE ESCC COMPONENT NUMBER AND COMPONENT TYPE VARIANTS

1.4.1 The ESCC Component Number

The ESCC Component number shall be constituted as follows:

Example: 930605101F

Detail Specification Reference: 9306051

Component Type Variant Number: 01 (as required)

Total Dose Radiation Level Letter: F (as required)

1.4.2 <u>Component Type Variants</u>

The component type variants applicable to this specification are as follows:

Variant Number	Based on Type	Case	Terminal Material and /or Finish	Weight max g	Total Dose Radiation Level Letter
01	54HC595	FP (G2 m/250	0.7	F [50kRAD(Si)]
02	54HC595	FP	G4	0.7	F [50kRAD(Si)]
05	54HC595	CCP	2	0.6	F [50kRAD(Si)]
10	54HC595	DIP	G2	2.2	F [50kRAD(Si)]
11	54HC595	DIP	G4	2.2	F [50kRAD(Si)]
12	54HC595	SO	G2	0.7	F [50kRAD(Si)]
13	54HC595	so	G4	0.7	F [50kRAD(Si)]



The terminal material and/or finish shall be in accordance with the requirements of ESCC Basic Specification No. 23500.

The total dose radiation level letter shall be as defined in ESCO Basic Specification No. 22900. If an alternative radiation test level is specified in the burchase order the letter shall be changed accordingly.

1.5 MAXIMUM RATINGS

The maximum ratings shall not be exceeded at any time during use or storage.

Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the applicable ESCC Generic Specification.

Characteristics	Symbols	Maximum Ratings	Units	Remarks
Supply Voltage	V _{DD}	-0.5 to 7	V	Note 1
Input Voltage	V _{IN}	-0.5 to V _{DD} +0.5	V	Notes 1, 2
Output Voltage	V _{OUT}	-0.5 to V _{DD} +0.5	V	Notes 1, 3
Device Power Dissipation (Continuous)	P _D	420	mW	Note 4
Supply Current	I _{DDop}	70	mA	<u> </u>
Operating Temperature Range	T _{op}	-55 to +125	°C	T _{amb}
Storage Temperature Range	T _{stg}	-65 to +150	°C	
Soldering Temperature For FP, DIP and SO For CCP	T _{sol}	+265 +245	°C	Note 5 Note 6

NOTES:

- Device is functional for 2V≤V_{DD}≤6V.
- 2. Input current limited to I_{IC}=±20mA.
- 3. Output current limited to I_{OUT}=±35mA.
- The maximum device dissipation is determined by I_{DDop} max (70mA)x6V.
- 5. Duration 10 seconds maximum at a distance of not less than 1.5mm from the device body and the same terminal shall not be resoldered until 3 minutes have elapsed.
- Duration 5 seconds maximum and the same terminal shall not be resoldered until 3 minutes have elapsed.

1.6 HANDLING PRECAUTIONS

These devices are susceptible to damage by electrostatic discharge. Therefore, suitable precautions shall be employed for protection during all phases of manufacture, testing, packaging, shipment and any handling.

These components are categorised as Class 2 per ESCC Basic Specification No. 23800 with a Minimum Critical Path Failure Voltage of 2500 Volts.

1.7 PHYSICAL DIMENSIONS AND TERMINAL IDENTIFICATION

Consolidated Notes are given following the case drawings and dimensions.



2. REQUIREMENTS

2.1 GENERAL

The complete requirements for procurement of the components specified herein are as stated in this specification and the applicable ESCC Generic Specification. Permitted deviations from the applicable Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the applicable Generic Specification and this Detail Specification, formally agreed with specific Manufacturers on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.

2.1.1 <u>Deviations from the Generic Specification</u>

None.

2.2 MARKING

The marking shall be in accordance with the requirements of ESCC Basic Specification No. 21700 and as follows.

The information to be marked on the component shall be:

- (a) Terminal identification.
- (b) The ESCC qualified components symbol (for ESCC qualified components only).
- (c) The ESCC Component Number.
- (d) Traceability information.

2.3 <u>ELECTRICAL MEASUREMENTS AT ROOM HIGH AND LOW TEMPERATURES</u>

Electrical measurements shall be performed at room, high and low temperatures. Consolidated Notes are given after the tables.

2.3.1 Room Temperature Electrical Measurements

The measurements shall be performed at T_{amb} =+22 ± 3°C.

Characteristics	Symbols	MIL-STD-883	Test Conditions	· ·	Units	
		Test Method	Note 1	Min	Max	
Functional Test 1	-	3014	Verify Truth Table without Load V _{IL} =0.3V,V _{IH} =1.5V V _{DD} =2V,V _{SS} =0V t _r <1µs, Note 2	-	-	-
Functional Test 2	-	3014	Verify Truth Table without Load V _{tL} =0.9V,V _{IH} =3.15V V _{DD} =4.5V,V _{SS} =0V t _r =t _r <500ns Note 2	-	-	-



	Characteristics	Symbols	MIL-STD-883	Test Conditions	Limits		Units
		e european d' european de la company	Test Method	Note 1	Min	Max	1
	Functional Test 3	-	3014	Verify Truth Table without Load V _{IL} =1.2V,V _{IH} =4.2V V _{DD} =6V,V _{SS} =0V t _r =t _f <400ns Note 2	-		•
	Quiescent Current	I _{DD}	3005	V _{IL} =0V,V _{IH} =6V V _{DD} =6V,V _{SS} =0V All Outputs Open Note 3	-	400	nA
	Low Level Input Current	I _{IL}	3009	V _{IN} (Under Test)=0V V _{IN} (Remaining Inputs)=6V V _{DD} =6V,V _{SS} =0V	*	-50	nA
	High Level Input Current	I _{IH}	3010	V _{IN} (Under Test)=6V V _{IN} (Remaining Inputs)=0V V _{DD} =6V,V _{SS} =0V	-	50	nA
	Low Level Output Voltage 1	V _{OL1}	3007	V _{IL} =0.3V, V _{IH} =1.5V, I _{OL} =20μA V _{DD} =2V, V _{SS} =0V	-	100	mV
	Low Level Output Voltage 2	V _{OL2}	3007	V _{IL} =0.9V, V _{IH} =3.15V, I _{OL} =20μA V _{DD} =4.5V, V _{SS} =0V	-	100	mV
	Low Level Output Voltage 3	V _{OL3}	3007	V _{IL} =1.2V, V _{IH} =4.2V, I _{OL} =20μΑ V _{DD} =6V, V _{SS} =0V		100	mV
QA, QB, QC, QD QE, QF, QG, QH	Low Level Output Voltage 4,	V _{OL4}	3007	V _{IL} =0.9V, V _{IH} =3.15V, I _{OL} =6mA V _{DD} =4.5V, V _{SS} =0V	-	260	mV
V	Low Level Output Voltage 5,	V _{OL5}	3007	V _{IL} =1.2V, V _{IH} =4.2V, I _{OL} =7.8mA V _{DD} =6V, V _{SS} =0V	-	260	mV
VOL6,7	High Level Output Voltage 1	V _{OH1}	3006	V _{IL} =0.3V, V _{IH} =1.5V, I _{OH} =-20μA V _{DD} =2V, V _{SS} =0V	1.9	-	٧
	High Level Output Voltage 2	V _{OH2}	3006	V _{IL} =0.9V, V _{IH} =3.15V, I _{OH} =-20μA V _{DD} =4.5V, V _{SS} =0V	4.4	_	V
	High Level Output Voltage 3	V _{OH3}	3006	V _{IL} =1.2V, V _{IH} =4.2V, I _{OH} =-20μA V _{DD} =6V, V _{SS} =0V	5.9	-	V
	High Level Output Voltage 4	V _{OH4}	3006	V _{IL} =0.9V, V _{IH} =3.15V, I _{OH} =-6mA V _{DD} =4.5V, V _{SS} =0V	3.98	-	V
1	Voltage 6, QH'	VOL6	3007	V _{IL} =0.9V, V _{IH} =3.15V I _{OL} =4mA V _{DD} =4.5V, V _{SS} =OV	_	260	mV
Ĺ	Low Level Dutent Voltage 7, CQH	VOL7	3007	V _{IL} =1.2V, V _{IH} =4.2V IOL=5.2mA V _{0D=6} V, V _{SS} =0V	_	260	mV

High level Dutput Voltage 6, QH'	YOHE	3006	VIL=0.9V, VIN=3.15V IDH= ~4MA VDB= 4.5V, VSS=OV	3.98	_	7
High Level Output Voltage 7, QH	VOH7	3006	Vil 21.2V, VIL 2 4.2V IOH = - 8.2MA VDD 26V, JSS 20V	5.48	_	V

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QA,QB,QC,QD QE,QF,QG,QH

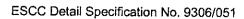
Characteristics	Symbols	MIL-STD-883	Test Conditions	Lin	nits	Units
		Test Method	Note 1	Min	Max	
High Level Output Voltage 5	3.1.5	3006	V _{IL} =1.2V, V _{IH} =4.2V, I _{OH} =-7.8mA V _{DD} =6V, V _{SS} =0V	5.48	•	V
Threshold Voltage N-Channel	V _{THN}	-	G Input at Ground All Other Inputs: V _{IN} =5V V _{DD} =5V, I _{SS} =-10μA	-0.45	-1.45	V
Threshold Voltage P-Channel	V _{THP}	-	G Input at Ground All Other Inputs: V _{IN} =-5V V _{SS} =-5V, I _{DD} =10μA	0.45	1.35	٧
Input Clamp Voltage to V _{SS}	V _{IC1}	-	I _{IN} (Under Test)= -0.1mA V _{DD} =Open, V _{SS} =0V All Other Pins Open	-400	-900	mV
Input Clamp Voltage to V _{DD}	V _{IC2}	-	I _{IN} (Under Test)= 0.1mA V _{DD} =0V, V _{SS} =Open All Other Pins Open	400	900	mV
Output Leakage Current Third State Low Level Applied	I _{OZL}	3020	V _{IN} (G)=6V V _{IN} (Remaining Inputs)=0V V _{OUT} =0V V _{DD} =6V, V _{SS} =0V	-	-500	nA
Output Leakage Current Third State High Level Applied	Гоzн	3021	V _{IN} (G)=6V V _{IN} (Remaining Inputs)=0V V _{OUT} =6V V _{DD} =6V, V _{SS} =0V	-	500	nA
Input Capacitance	C _{IN}	3012	V _{IN} (Not Under Test)=0V V _{DD} = V _{SS} =0V f = 100 kHz to 1 MHz Note 4	0 -	10	pF
Propagation Delay Low to High 1, SRCLK to QH'	t _{PLH1}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	32	ns
Propagation Delay High to Low 1, SRCLK to QH'	[‡] PHL1	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	32	ns

\ VIL=04, VIH \$51



Characteristics			Lir	nits	Units	
		Test Method	Note 1	Min	Max	1
Propagation Delay Low to High 2, RCLK to QH	t _{PLH2}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	35	ns
Propagation Delay High to Low 2, RCLK to QH	t _{PHL2}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	35	ns
Propagation Delay High to Low 3 SRCLR to QH	t _{PHL3}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	35	ns
Transition Time Low to High 1, QH	[†] ⊤LH1	3004	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	15	ns
Transition Time High to Low 1, QH	t _{THL1}	3004	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	15	ns
Transition Time Low to High 2, QH	t _{TLH2}	3004	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	12	ns
Transition Time High to Low 2, QH	t _{THL2}	3004	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	12	ns
Output Enable Time High Impedance to Low Output G to QA	t _{PZL}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) =0V V _{DD} =4.5V, V _{SS} =0V Note 5	-	30	ns
Output Enable Time High Impedance to High Output	t _{PZH}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) =0V V _{DD} =4.5V, V _{SS} =0V Note 5	-	30	ns

QH1)





VIL=01, VIH 45V

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Characteristics	Symbols	MIL-STD-888	Test Conditions	Lin	Units	
		Test Method	Note 1	Min	Max	
Output Disable Time Low Output to High Impedance G to QAS	t _{PLZ}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth Table V _{DD} =4.5V, V _{SS} =0V Note 5	-	40	ns
Output Disable Time High Output to High Impedance	t _{PHZ}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth Table V _{DD} =4.5V, V _{SS} =0V Note 5	-	40	ns
Maximum Clock Frequency	f _{CLK})	. (SRCLK = RCLK = Pulse Generator V _{DD} =4.5V, V _{SS} =0V Notes 6, 7	30	-	MHz

2.3.2 <u>High and Low Temperatures Electrical Measurements</u>

The measurements shall be performed at T_{amb} =+125 (+0 -5) o C and T_{amb} =- 55(+5-0) o C.

Characteristics	Symbols	MIL-STD-883	Test Conditions	Lir	nits	Units
		Test Method	Note 1	Min	Max	1
Functional Test 1	<u>-</u>	3014	$\begin{tabular}{ll} Verify Truth Table\\ without Load\\ V_{IL}=0.3V,V_{IH}=1.5V\\ V_{DD}=2V,V_{SS}=0V\\ t_r<1\mu s,\ Note\ 2\\ \end{tabular}$	-	-	-
Functional Test 2	-	3014	Verify Truth Table without Load V _{IL} =0.9V,V _{IH} =3.15V V _{DD} =4.5V,V _{SS} =0V t _r =t _f <500ns Note 2	-	-	_
Functional Test 3	-	3014	Verify Truth Table without Load V_{IL} =1.2 V , V_{IH} =4.2 V V_{DD} =6 V , V_{SS} =0 V t_r = t_r <400ns Note 2	-	-	-
Quiescent Current	I _{DD}	3005	V _{IL} =0V,V _{IH} =6V V _{DD} =6V,V _{SS} =0V All Outputs Open Note 3	-	8	μΑ
Low Level Input Current	I _{IL}	3009	V _{IN} (Under Test)=0V V _{IN} (Remaining Inputs)=6V V _{DD} =6V,V _{SS} =0V	-	-1	μА



	Characteristics	Symbols	MIL-STD-883	Test Conditions	Limits		Units
			Test Method	Note 1	Min	Max	
	High Level Input Current	ħн	3010	V _{IN} (Under Test)=6V V _{IN} (Remaining Inputs)=0V V _{DD} =6V,V _{SS} =0V	-	1	μА
	Low Level Output Voltage 1	V _{OL1}	3007	V_{IL} =0.3V, V_{IH} =1.5V, I_{OL} =20 μ A V_{DD} =2V, V_{SS} =0V	-	100	mV
	Low Level Output Voltage 2	V _{OL2}	3007	V _{IL} =0.9V, V _{IH} =3.15V, I _{OL} =20μΑ V _{DD} =4.5V, V _{SS} =0V	-	100	mV
QA, &&, QC, &D	Low Level Output Voltage 3	V _{OL3}	3007	V _{IL} =1.2V, V _{IH} =4.2V, I _{OL} =20µA V _{DD} =6V, V _{SS} =0V	1	100	mV
QE at ac ah	Low Level Output Voltage 4,	V _{OL4}	3007	V _{IL} =0.9V, V _{IH} =3.15V, I _{OL} =6mA V _{DD} =4.5V, V _{SS} =0V	1	400	mV
	Low Level Output Voltage 5,	V _{OL5}	3007	V _{IL} =1.2V, V _{IH} =4.2V, I _{OL} =7.8mA V _{DD} =6V, V _{SS} =0V	-	400	mV
Vole, Volt ->	High Level Output Voltage 1	V _{OH1}	3006	V _{IL} =0.3V, V _{IH} =1.5V, I _{OH} =-20μA V _{DD} =2V, V _{SS} =0V	1.9	-	V
	High Level Output Voltage 2	V _{OH2}	3006	V _{IL} =0.9V, V _{IH} =3.15V, I _{OH} =-20μA V _{DD} =4.5V, V _{SS} =0V	4.4	-	V
QA, QB, QC, QD	High Level Output Voltage 3	V _{ОН3}	3006	V _{IL} =1.2V, V _{IH} =4.2V, I _{OH} =-20μA V _{DD} =6V, V _{SS} =0V	5.9	-	V
QE,QF,QG,QH	High Level Output Voltage 4,	V _{OH4}	3006	V _{IL} =0.9V, V _{IH} =3.15V, I _{OH} =-6mA V _{DD} =4.5V, V _{SS} =0V	3.7	-	V
	High Level Output Voltage 5,	V _{OH5}	3006	V _{IL} =1.2V, V _{IH} =4.2V, I _{OH} =-7.8mA V _{DD} =6V, V _{SS} =0V	5.2	-	V
VOH6, VOH7 as per paye 17 with limit	Input Clamp Voltage (to V _{SS})	V _{IC1}	-	I _{IN} (Under Test)= -0.1mA V _{DD} =Open, V _{SS} =0V All Other Pins Open	-0.1	-1.2	V
Vou6 = 3.7V Vou7 = 5.2V	Input Clamp Voltage (to V _{DD})	V _{IC2}	-	I _{IN} (Under Test)= 0.1mA V _{DD} =0V, V _{SS} =Open All Other Pins Open	0.1	1.2	V



Characteristics	Symbols	MIL-STD-883			nits	Units
		Test Method	d Note 1	Min	Max	
Output Leakage Current Third State Low Level Applied	l _{OZL}	3020	V _{IN} (G)=6V V _{IN} (Remaining Inputs)=0V V _{OUT} =0V V _{DD} =6V, V _{SS} =0V	-	-10	μА
Output Leakage Current Third State High Level Applied	Гохн	3021	V _{IN} (G)=6V V _{IN} (Remaining Inputs)=0V V _{OUT} =6V V _{DD} =6V, V _{SS} =0V	-	10	μА

Notes to Electrical Measurement Tables outputs not under test show the open.

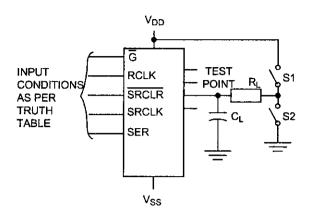
- 2.3.3
 - Unless otherwise specified all inputs and outputs shall be tested for each characteristic,) Functional tests shall be performed with f = 10 kHz (min). The Maximum time to output comparator strobe=30µs.
 - Quiescent Current shall be tested using the following input conditions:
 - (a) All inputs = V_{II}
 - (b) $\overline{G} = V_{IL}$; $\overline{SRCLR} = SER = V_{IH}$; SRCLK = RCLK = 9 low to high transitions to configure the outputs to a high level.
 - Guaranteed but not tested.
 - Measurements shall be performed as a go-no-go test on a 100% basis. Read and record measurements shall be performed on a sample of 5 components.

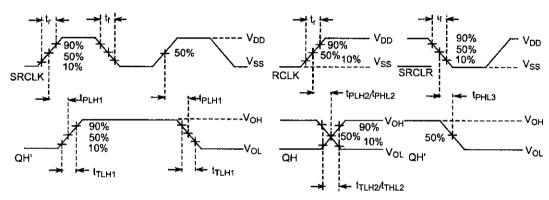
The pulse generator shall have the following characteristics:

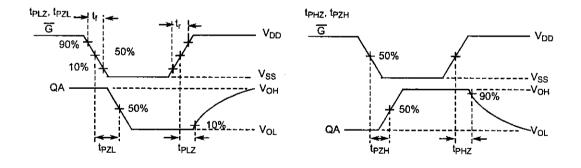
 V_{GEN} = 0 to V_{DD} ; f = 1 MHz minimum; t_r and $t_f \le 6$ ns (10% to 90%); duty cycle = 50%; Z_{out} = 50Ω Output load capacitance C_L = 50pF ± 5% including scope probe, wiring and stray capacitance without component in the test fixture and output load resistance R_L = 1k Ω ± 5%. Propagation delay and transition time shall be measured as follows:

PARAMETER	R_{L}	CL	S1	S2
t _{PZH}	1 kΩ	50pF	OPEN	CLOSED
t _{PZL}			CLOSED	OPEN
t _{PHZ}	1 kΩ	50pF	OPEN	CLOSED
t _{PLZ}			CLOSED	OPEN
t _{PHL} ,t _{PLH} , t _{THL} , t _{TLH}	-	50pF	OPEN	OPEN









- 6. Read and record measurements shall be made on a sample of 5 components, with O failurs permitted.
- 7. A pulse, having the following conditions, shall be applied to the cleck inputs: $V_P = 0V$ to V_{DD} We.

Maximum Clock frequency (CSK) requirement shall be considered as met if proper output state changes occur with the pulse repetition rate set to that given in the "Limits" column.

Limits



2.4 PARAMETER DRIFT VALUES

Unless otherwise specified, the measurements shall be performed at T_{amb} =+22±3°C.

The test methods and test conditions shall be as per the corresponding test defined in Electrical Measurements at Room Temperature, Electrical Measurements.

The drift values (Δ) shall not be exceeded for each characteristic specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

Characteristics	Symbols		Limits		Units
		Drift	Abs	olute	
		Value Δ	Min	Max	
Quiescent Current	I _{DD}	±120	-	400	nA
Low Level Input Current	I _{IL}	±20	-	-50	nA
High Level Input Current	I _{IH}	±20	-	50	пA
Low Level Output Voltage 4	V _{OL4}	±26	-	260	mV
High Level Output Voltage 4	V _{OH4}	±0.2	3.98	-	V
Threshold Voltage N-Channel	V _{THN}	±0.3	-0.45	-1.45	V
Threshold Voltage P-Channel	V _{THP}	±0.3	0.45	1.35	V

, V_{он}6

NOTES:

Unless otherwise specified all inputs and outputs shall be tested for each characteristic.

2.5 <u>INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS</u>

Unless otherwise specified, the measurements shall be performed at T_{amb} =+22 \pm 3°C.

The test methods and test conditions shall be as per the corresponding test defined in Electrical Measurements at Room Temperature, Electrical Measurements.

The drift values (Δ) shall not be exceeded for each characteristic where specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

LowLevel Output Volkage 6	Vole	±26	_	260	m۷
High Level Output Voltage 6	V _{OH6}	±0.2	3.98	-	V



Characteristics	Symbols		Limits	: :	Units
		Drift Value	Abs	olute	
		Δ	Min	Max	
Functional Test 1	-	-	-	-	-
Functional Test 2		-	-	-	-
Functional Test 3	-	-	-	-	-
Quiescent Current	I _{DD}	±120	-	400	nA
Low Level Input Current	I _{IL}	±20	-	-50	nA
High Level Input Current	I _{IH}	±20	-	50	nA
Low Level Output Voltage 4	V _{OL4}	±26	-	260	mV
Low Level Output Voltage 5	V_{OL5}	±26	-	260	mV
High Level Output Voltage 4	V _{OH4}	±0.2	3.98	-	V
High Level Output Voltage 5	V _{OH5}	±0.2	5.48	-	V
Threshold Voltage N-Channel	V _{THN}	±0.3	-0.45	-1.45	V
Threshold Voltage P-Channel	V _{THP}	±0.3	0.45	1.35	V
Output Leakage Current Third State, Low Level Applied	lozL	±200	-	-500	nA
Output Leakage Current Third State, High Level Applied	l _{ozh}	±200	-	500	nA

VOL6, VOL7 →

NOTES:

Unless otherwise specified all inputs and outputs shall be tested for each characteristic.

The drift values (Δ) are applicable to the Operating Life test only.

Law Level Dutput Voltage 6	VOLG	±26	_	260	m٧
Low Level Ontonk Voltage 7	Vol7	±26	_	260	mV
High Level Onkent Voltrage 6	Vous	±0.2	3.98	-	٧
High Lovel Output Voltage 7	Vou7	±0.2	5.48	1	V



2.6 <u>HIGH TEMPERATURE REVERSE BIAS BURN-IN CONDITIONS</u>

2.6.1 N-Channel HTRB

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T _{amb}	+125 (+0 -5)	°C
Outputs QA, QB, QC, QD, QE, QF, QG, QH, QH'	V _{OUT}	Open or V _{SS}	·v
Inputs SRCLR, SRCLK, RCLK, G, SER	V _{IN}	V _{SS}	V
Positive Supply Voltage	V _{DD}	6 (+0 -0.5)	V
Negative Supply Voltage	V _{SS}	0	V
Duration	t ·	72	Hours

NOTES:

- 1. Input Protection Resistor = 680Ω min to $47k\Omega$ max.
- 2. Output Load = $1k\Omega$ min to $10k\Omega$ max.

2.6.2 P-Channel HTRB

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T _{amb}	+125 (+0 -5)	°C
Outputs QA, QB, QC, QD, QE, QF, QG, QH, QH'	V _{OUT}	Open or V _{DD}	·V
Inputs SRCLR, SRCLK, RCLK, G, SER	V _{IN}	V _{DD}	V
Positive Supply Voltage	V _{DD}	6 (+0 -0.5)	V
Negative Supply Voltage	V _{SS}	0	V
Duration	t	72	Hours

NOTES:

- 1. Input Protection Resistor = 680Ω min to $47k\Omega$ max.
- 2. Output Load = $1k\Omega$ min to $10k\Omega$ max.



2.7 POWER BURN-IN CONDITIONS

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T _{amb}	+125 (+0 -5)	°C
Outputs QA, QB, QC, QD, QE, QF, QG, QH, QH'	V _{OUT}	V _{DD}	V
Inputs SRCLR, SER	V _{IN}	V _{DD}	V
Inputs SRCLK, RCLK	V _{IN}	V _{GEN1}	V
Input G	V _{IN}	V _{GEN2}	V
Pulse Voltage	V _{GEN}	0V to V _{DD}	V
Pulse Frequency Square Wave	f _{GEN1} f _{GEN2}	100k ± 10% 50k ± 10% 50 ± 15% Duty Cycle t _r =t _f ≤400ns	Hz
Positive Supply Voltage	V _{DD}	6 (+0 -0.5)	V
Negative Supply Voltage	V _{SS}	0	V

NOTES:

- 1. Input Protection Resistor = 680Ω min to $47k\Omega$ max.
- 2. Output Load = $1k\Omega$ min to $10k\Omega$ max.

2.8	OPERATING LIFE CONDITIONS
	The conditions shall be as specified for power burn-in

2.9 TOTAL DOSE RADIATION TESTING

2.9.1 Bias Conditions and Total Dose Level for Total Dose Radiation Testing

Continuous bias shall be applied during irradiation testing as specified below.

The total dose level applied shall be as specified in the component type variant information herein or in the purchase order.



Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T _{amb}	+ 22 ± 3	°C
Outputs QA, QB, QC, QD, QE, QF, QG, QH, QH'	V _{OUT}	Open	('V
Inputs SRCLR, G	V _{IN}	V _{SS}	V
Inputs SRCLK, RCLK, SER	V _{IN}	V_{DD}	V
Positive Supply Voltage	V _{DD}	6 ± 0.3	V
Negative Supply Voltage	V _{SS}	0	V

NOTES:

2.9.2 <u>Electrical Measurements for Total Dose Radiation Testing</u>

Prior to irradiation testing the devices shall have successfully met Room Temperature Electrical Measurements specified herein.

Unless otherwise stated the measurements shall be performed at T_{amb} = +22 ± 3 °C. The test methods and test conditions shall be as per the corresponding test defined in Electrical Measurements at Room Temperature, Electrical Measurements.

The parameters to be measured during and on completion of irradiation testing are shown below.

Unless otherwise specified all inputs and outputs shall be tested for each characteristic.

Characteristics	Symbols		Units		
		Drift	Abs	Absolute	
		Values Δ	Min	Max	
Quiescent Current	I _{DD}	-	-	40	μΑ
Threshold Voltage N-Channel	V _{THN}	±0.6	-0.4	-1.5	V
Threshold Voltage P-Channel	V _{THP}	±0.6	0.4	1.4	V

^{1.} Input Protection Resistor = 680Ω min to $47k\Omega$ max.



APPENDIX 'A'

AGREED DEVIATIONS FOR STMICROELECTRONICS (F)

ITEMS AFFECTED	DESCRIPTION OF DEVIATIONS
Deviations from Screening Tests - Chart F3	External Visual Inspection: The criteria applicable to chip out are those described in MIL-STD-883, Test Method 2009, Paras 3.3.6(b) and 3.3.7(a).
	High Temperature Reverse Bias Burn-in: The temperature limits of MIL-STD-883, Para. 4.5.8(c) may be used.
	Power Burn-in test is performed using STMicroelectronics Specification Ref: 0019255.
Deviations from Qualification and Periodic Tests - Chart	External Visual Inspection: The criteria applicable to chip out are those described in MIL-STD-883, Test Method 2009, Paras 3.3.6(b) and 3.3.7(a).
F4	Operating Life: The temperature limits of MIL-STD-883, Para. 4.5.8(c) may be used.
Deviations from Electrical Measuremente et High and Low Temperatures	Glectrical Measurements at High and Low Temperatures may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes High and Low Temperature Electrical Measurements per the detail specification.
Electrical	Woods of the detail specification.
Measurene	A summary of the pilot lot testing shall be provided if required by the Burchase order.
Deviations from Room Temperature Electrical Measurements	All AC characteristics (Capacitance and Timings) may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes AC characteristic measurements per the detail specification.
	A summary of the pilot lot testing shall be provided if required by the burchase order.

Marker Per Der. Sithacker.



Pages 1 to 28

8-BIT SHIFT REGISTER WITH 3-STATE OUTPUT REGISTER

BASED ON TYPE 54HC595

ESCC Detail Specification No. 9306/051

3	September 2004
Issue 2	October 2003







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2004

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ISSUE 2

DOCUMENTATION CHANGE NOTICE

(Refer to https://escies.org for ESCC DCR content)

DCR No.	CHANGE DESCRIPTION
198	Specification upissued to incorporate editorial and technical changes per DCR.

per allocated



1. GENERAL

1.1 SCOPE

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type variants and/or the range of components specified below. It supplements the requirements of, and shall be read in conjunction with, the ESCC Generic Specification listed under Applicable Documents.

1.2 APPLICABLE DOCUMENTS

The following documents form part of this specification and shall be read in conjunction with it:

- (a) ESCC Generic Specification No. 9000.
- (b) MIL-STD-883, Test Methods and Procedures for Microelectronics.

1.3 <u>TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS</u>

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Basic Specification No. 21300 shall apply.

1.4 THE ESCC COMPONENT NUMBER AND COMPONENT TYPE VARIANTS

1.4.1 The ESCC Component Number

The ESCC Component number shall be constituted as follows:

Example: 930605101F

Detail Specification Reference: 9306051

Component Type Variant Number: 01 (as required)

Total Dose Radiation Level Letter: F (as required)

1.4.2 <u>Component Type Variants</u>

The component type variants applicable to this specification are as follows:

Variant Number	Based on Type	Case	Terminal Material and /or Finish	Weight max g	Total Dose Radiation Level Letter
01	54HC595	FP (G2 m/250	0.7	F [50kRAD(Si)]
02	54HC595	FP	G4	0.7	F [50kRAD(Si)]
05	54HC595	CCP	2	0.6	F [50kRAD(Si)]
10	54HC595	DIP	G2	2.2	F [50kRAD(Si)]
11	54HC595	DIP	G4	2.2	F [50kRAD(Si)]
12	54HC595	SO	G2	0.7	F [50kRAD(Si)]
13	54HC595	so	G4	0.7	F [50kRAD(Si)]



The terminal material and/or finish shall be in accordance with the requirements of ESCC Basic Specification No. 23500.

The total dose radiation level letter shall be as defined in ESCO Basic Specification No. 22900. If an alternative radiation test level is specified in the burchase order the letter shall be changed accordingly.

1.5 MAXIMUM RATINGS

The maximum ratings shall not be exceeded at any time during use or storage.

Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the applicable ESCC Generic Specification.

Characteristics	Symbols	Maximum Ratings	Units	Remarks
Supply Voltage	V _{DD}	-0.5 to 7	V	Note 1
Input Voltage	V _{IN}	-0.5 to V _{DD} +0.5	V	Notes 1, 2
Output Voltage	V _{OUT}	-0.5 to V _{DD} +0.5	V	Notes 1, 3
Device Power Dissipation (Continuous)	P _D	420	mW	Note 4
Supply Current	I _{DDop}	70	mA	<u> </u>
Operating Temperature Range	T _{op}	-55 to +125	°C	T _{amb}
Storage Temperature Range	T _{stg}	-65 to +150	°C	
Soldering Temperature For FP, DIP and SO For CCP	T _{sol}	+265 +245	°C	Note 5 Note 6

NOTES:

- Device is functional for 2V≤V_{DD}≤6V.
- 2. Input current limited to I_{IC}=±20mA.
- 3. Output current limited to I_{OUT}=±35mA.
- The maximum device dissipation is determined by I_{DDop} max (70mA)x6V.
- 5. Duration 10 seconds maximum at a distance of not less than 1.5mm from the device body and the same terminal shall not be resoldered until 3 minutes have elapsed.
- Duration 5 seconds maximum and the same terminal shall not be resoldered until 3 minutes have elapsed.

1.6 HANDLING PRECAUTIONS

These devices are susceptible to damage by electrostatic discharge. Therefore, suitable precautions shall be employed for protection during all phases of manufacture, testing, packaging, shipment and any handling.

These components are categorised as Class 2 per ESCC Basic Specification No. 23800 with a Minimum Critical Path Failure Voltage of 2500 Volts.

1.7 PHYSICAL DIMENSIONS AND TERMINAL IDENTIFICATION

Consolidated Notes are given following the case drawings and dimensions.



2. REQUIREMENTS

2.1 GENERAL

The complete requirements for procurement of the components specified herein are as stated in this specification and the applicable ESCC Generic Specification. Permitted deviations from the applicable Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the applicable Generic Specification and this Detail Specification, formally agreed with specific Manufacturers on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.

2.1.1 <u>Deviations from the Generic Specification</u>

None.

2.2 MARKING

The marking shall be in accordance with the requirements of ESCC Basic Specification No. 21700 and as follows.

The information to be marked on the component shall be:

- (a) Terminal identification.
- (b) The ESCC qualified components symbol (for ESCC qualified components only).
- (c) The ESCC Component Number.
- (d) Traceability information.

2.3 <u>ELECTRICAL MEASUREMENTS AT ROOM HIGH AND LOW TEMPERATURES</u>

Electrical measurements shall be performed at room, high and low temperatures. Consolidated Notes are given after the tables.

2.3.1 Room Temperature Electrical Measurements

The measurements shall be performed at T_{amb} =+22 ± 3°C.

Characteristics	Symbols MIL-STD-883	Test Conditions	Limits		Units	
		Test Method	Note 1	Min	Max	
Functional Test 1	-	3014	Verify Truth Table without Load V _{IL} =0.3V,V _{IH} =1.5V V _{DD} =2V,V _{SS} =0V t _r <1µs, Note 2	-	-	-
Functional Test 2	-	3014	Verify Truth Table without Load V _{tL} =0.9V,V _{IH} =3.15V V _{DD} =4.5V,V _{SS} =0V t _r =t _r <500ns Note 2	-	-	-



	Characteristics			Test Conditions	Limits		Units
		e european d' european de la company	Test Method	Note 1	Min	Max	1
	Functional Test 3	-	3014	Verify Truth Table without Load V _{IL} =1.2V,V _{IH} =4.2V V _{DD} =6V,V _{SS} =0V t _r =t _f <400ns Note 2			•
	Quiescent Current	I _{DD}	3005	V _{IL} =0V,V _{IH} =6V V _{DD} =6V,V _{SS} =0V All Outputs Open Note 3	-	400	nA
	Low Level Input Current	I _{IL}	3009	V _{IN} (Under Test)=0V V _{IN} (Remaining Inputs)=6V V _{DD} =6V,V _{SS} =0V	*	-50	nA
	High Level Input Current	I _{IH}	3010	V _{IN} (Under Test)=6V V _{IN} (Remaining Inputs)=0V V _{DD} =6V,V _{SS} =0V	-	50	nA
	Low Level Output Voltage 1	V _{OL1}	3007	V _{IL} =0.3V, V _{IH} =1.5V, I _{OL} =20μA V _{DD} =2V, V _{SS} =0V	-	100	mV
	Low Level Output Voltage 2	V _{OL2}	3007	V _{IL} =0.9V, V _{IH} =3.15V, I _{OL} =20μA V _{DD} =4.5V, V _{SS} =0V	-	100	mV
	Low Level Output Voltage 3	V _{OL3}	3007	V _{IL} =1.2V, V _{IH} =4.2V, I _{OL} =20μΑ V _{DD} =6V, V _{SS} =0V		100	mV
QA, QB, QC, QD QE, QF, QG, QH	Low Level Output Voltage 4,	V _{OL4}	3007	V _{IL} =0.9V, V _{IH} =3.15V, I _{OL} =6mA V _{DD} =4.5V, V _{SS} =0V	-	260	mV
V	Low Level Output Voltage 5,	V _{OL5}	3007	V _{IL} =1.2V, V _{IH} =4.2V, I _{OL} =7.8mA V _{DD} =6V, V _{SS} =0V	-	260	mV
VOL6,7	High Level Output Voltage 1	V _{OH1}	3006	V _{IL} =0.3V, V _{IH} =1.5V, I _{OH} =-20μA V _{DD} =2V, V _{SS} =0V	1.9	-	٧
	High Level Output Voltage 2	V _{OH2}	3006	V _{IL} =0.9V, V _{IH} =3.15V, I _{OH} =-20μA V _{DD} =4.5V, V _{SS} =0V	4.4	_	V
	High Level Output Voltage 3	V _{OH3}	3006	V _{IL} =1.2V, V _{IH} =4.2V, I _{OH} =-20μA V _{DD} =6V, V _{SS} =0V	5.9	-	V
	High Level Output Voltage 4	V _{OH4}	3006	V _{IL} =0.9V, V _{IH} =3.15V, I _{OH} =-6mA V _{DD} =4.5V, V _{SS} =0V	3.98	-	V
1	Voltage 6, QH'	VOL6	3007	V _{IL} =0.9V, V _{IH} =3.15V I _{OL} =4mA V _{DD} =4.5V, V _{SS} =OV	_	260	mV
Ĺ	Low Level Dutent Voltage 7, CQH	VOL7	3007	V _{IL} =1.2V, V _{IH} =4.2V IOL=5.2mA V _{0D=6} V, V _{SS} =0V	_	260	mV

High Level Dutput Voltage 6, QH'	NOHP	એ૦૦૬	VIL=0.9V, VIH=3-15V IOH=-4MA VDB=4.5V, VSS=OV	3.98	_	7
High Level Output Voltage 7, QH	VOH7	3006	VL=1.2V, VIL=4.2V TOH=-6.2MA VDD=6V, VSS=OV	5.48	_	V

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QA,QB,QC,QD QE,QF,QC,QH

Characteristics	Symbols MIL-STD-883		Test Conditions	Lir	Units	
		Test Method	Note 1	Min	Max	
High Level Output Voltage 5	V _{ОН5} ,	3006	V _{IL} =1.2V, V _{IH} =4.2V, I _{OH} =-7.8mA V _{DD} =6V, V _{SS} =0V	5.48	-	V
Threshold Voltage N-Channel	V _{THN}	•	G Input at Ground All Other Inputs: V _{IN} =5V V _{DD} =5V, I _{SS} =-10μA	-0.45	-1.45	V
Threshold Voltage P-Channel	V _{THP}	-	G Input at Ground All Other Inputs: V _{IN} =-5V V _{SS} =-5V, I _{DD} =10μA	0.45	1.35	٧
Input Clamp Voltage to V _{SS}	V _{IC1}	-	I _{IN} (Under Test)= -0.1mA V _{DD} =Open, V _{SS} =0V All Other Pins Open	-400	-900	mV
Input Clamp Voltage ≹to V _{DD} }	V _{IC2}	-	I _{IN} (Under Test)= 0.1mA V _{DD} =0V, V _{SS} =Open All Other Pins Open	400	900	mV
Output Leakage Current Third State Low Level Applied	l _{OZL}	3020	V _{IN} (G)=6V V _{IN} (Remaining Inputs)=0V V _{OUT} =0V V _{DD} =6V, V _{SS} =0V	-	-500	nA
Output Leakage Current Third State High Level Applied	l _{OZH}	3021	V _{IN} (G)=6V V _{IN} (Remaining Inputs)=0V V _{OUT} =6V V _{DD} =6V, V _{SS} =0V	-	500	nA
Input Capacitance	C _{IN}	3012	V _{IN} (Not Under Test)=0V V _{DD} = V _{SS} =0V f = 100 kHz to 1 MHz Note 4	-	10	pF
Propagation Delay Low to High 1, SRCLK to QH'	^t PLH1	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	32	ns
Propagation Delay High to Low 1, SRCLK to QH'	t _{PHL1}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	32	ns

(VIL=OV, VIN=5V



Characteristics	Symbols	MIL-STD-883	Test Conditions	Limits		Units
		Test Method	Note 1	Min	Max	
Propagation Delay Low to High 2, RCLK to QH	t _{PLH2}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	35	ns
Propagation Delay High to Low 2, RCLK to QH	t _{PHL2}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	•	35	ns
Propagation Delay High to Low 3 SRCLR to QH	t _{PHL3}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	_	35	ns
Transition Time Low to High 1, QH	t _{TLH1}	3004	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	15	ns
Transition Time High to Low 1, QH	t _{THL1}	3004	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	15	ns
Transition Time Low to High 2, QH	t _{TLH2}	3004	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	12	ns
Transition Time High to Low 2, QH	t _{THL2}	3004	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth table V _{DD} =4.5V, V _{SS} =0V Note 5	-	12	ns
Output Enable Time High Impedance to Low Output G to QA	t _{PZL}	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) =0V V _{DD} =4.5V, V _{SS} =0V Note 5	1	30	ns
Output Enable Time High Impedance to High Output	^t PZH	3003	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) =0V V _{DD} =4.5V, V _{SS} =0V Note 5	-	30	ns

(RH1)

VIL=01, VIH=5V

Characteristics	Symbols MIL-STD-888		1	Test Conditions	Lin	Units	
		Test Metho	d	Note 1	Min	Max	1
Output Disable Time Low Output to High Impedance G to QA	t _{PLZ}	3003		V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth Table V _{DD} =4.5V, V _{SS} =0V Note 5	-	40	ns
Output Disable Time High Output to High Impedance G to A	t _{PHZ}	3003	بر	V _{IN} =Pulse Generator V _{IN} (Remaining Inputs) per Truth Table V _{DD} =4.5V, V _{SS} =0V Note 5	<u>-</u>	40	ns
Maximum Clock Frequency	f _{CLK})	- (~~;	SRCLK = RCLK = Pulse Generator V _{DD} =4.5V, V _{SS} =0V Notes 6, 7	30		MHz

2.3.2 <u>High and Low Temperatures Electrical Measurements</u>

The measurements shall be performed at T_{amb} =+125 (+0 -5) o C and T_{amb} =- 55(+5-0) o C.

Characteristics				Lin	nits	Units
		Test Method	Note 1	Min	Max	1
Functional Test 1	-	3014	Verify Truth Table without Load V _{IL} =0.3V,V _{IH} =1.5V V _{DD} =2V,V _{SS} =0V t _r <1μs, Note 2	-	**	-
Functional Test 2	-	3014	Verify Truth Table without Load V _{IL} =0.9V,V _{IH} =3.15V V _{DD} =4.5V,V _{SS} =0V t _r =t _r <500ns Note 2	-	-	_
Functional Test 3	-	3014	Verify Truth Table without Load V _{IL} =1.2V,V _{IH} =4.2V V _{DD} =6V,V _{SS} =0V t _r =t _r <400ns Note 2	-	-	
Quiescent Current	l _{DD}	3005	V _{IL} =0V,V _{IH} =6V V _{DD} =6V,V _{SS} =0V All Outputs Open Note 3	-	8	μА
Low Level Input Current	I _{IL}	3009	V _{IN} (Under Test)=0V V _{IN} (Remaining Inputs)=6V V _{DD} =6V,V _{SS} =0V	•	-1	μΑ



	Characteristics	Symbols	MIL-STD-883	Test Conditions	Limits		Units
			Test Method	Note 1	Min	Max	
	High Level Input Current	ħн	3010	V _{IN} (Under Test)=6V V _{IN} (Remaining Inputs)=0V V _{DD} =6V,V _{SS} =0V	-	1	μА
	Low Level Output Voltage 1	V _{OL1}	3007	V_{IL} =0.3V, V_{IH} =1.5V, I_{OL} =20 μ A V_{DD} =2V, V_{SS} =0V	-	100	mV
	Low Level Output Voltage 2	V _{OL2}	3007	V _{IL} =0.9V, V _{IH} =3.15V, I _{OL} =20μΑ V _{DD} =4.5V, V _{SS} =0V	-	100	mV
QA, &&, QC, &D	Low Level Output Voltage 3	V _{OL3}	3007	V _{IL} =1.2V, V _{IH} =4.2V, I _{OL} =20µA V _{DD} =6V, V _{SS} =0V	1	100	mV
QE at ac ah	Low Level Output Voltage 4,	V _{OL4}	3007	V _{IL} =0.9V, V _{IH} =3.15V, I _{OL} =6mA V _{DD} =4.5V, V _{SS} =0V	1	400	mV
	Low Level Output Voltage 5,	V _{OL5}	3007	V _{IL} =1.2V, V _{IH} =4.2V, I _{OL} =7.8mA V _{DD} =6V, V _{SS} =0V	-	400	mV
Vole, Volt ->	High Level Output Voltage 1	V _{OH1}	3006	V _{IL} =0.3V, V _{IH} =1.5V, I _{OH} =-20μA V _{DD} =2V, V _{SS} =0V	1.9	-	V
	High Level Output Voltage 2	V _{OH2}	3006	V _{IL} =0.9V, V _{IH} =3.15V, I _{OH} =-20μA V _{DD} =4.5V, V _{SS} =0V	4.4	-	V
QA, QB, QC, QD	High Level Output Voltage 3	V _{ОН3}	3006	V _{IL} =1.2V, V _{IH} =4.2V, I _{OH} =-20μA V _{DD} =6V, V _{SS} =0V	5.9	-	V
QE,QF,QG,QH	High Level Output Voltage 4,	V _{OH4}	3006	V _{IL} =0.9V, V _{IH} =3.15V, I _{OH} =-6mA V _{DD} =4.5V, V _{SS} =0V	3.7	-	V
	High Level Output Voltage 5,	V _{OH5}	3006	V _{IL} =1.2V, V _{IH} =4.2V, I _{OH} =-7.8mA V _{DD} =6V, V _{SS} =0V	5.2	-	V
VOH6, VOH7 as per paye 17 with limit	Input Clamp Voltage (to V _{SS})	V _{IC1}	-	I _{IN} (Under Test)= -0.1mA V _{DD} =Open, V _{SS} =0V All Other Pins Open	-0.1	-1.2	V
Vou6 = 3.7V Vou7 = 5.2V	Input Clamp Voltage (to V _{DD})	V _{IC2}	-	I _{IN} (Under Test)= 0.1mA V _{DD} =0V, V _{SS} =Open All Other Pins Open	0.1	1.2	V



Characteristics			Limits		Units	
		Test Method	Test Method Note 1	Min	Max	
Output Leakage Current Third State Low Level Applied	l _{OZL}	3020	V _{IN} (G)=6V V _{IN} (Remaining Inputs)=0V V _{OUT} =0V V _{DD} =6V, V _{SS} =0V	-	-10	μА
Output Leakage Current Third State High Level Applied	Гохн	3021	V _{IN} (G)=6V V _{IN} (Remaining Inputs)=0V V _{OUT} =6V V _{DD} =6V, V _{SS} =0V	-	10	μА

Notes to Electrical Measurement Tables outputs not under test show the open.

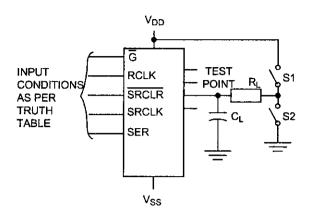
- 2.3.3
 - Unless otherwise specified all inputs and outputs shall be tested for each characteristic,) Functional tests shall be performed with f = 10 kHz (min). The Maximum time to output comparator strobe=30µs.
 - Quiescent Current shall be tested using the following input conditions:
 - (a) All inputs = V_{II}
 - (b) $\overline{G} = V_{IL}$; $\overline{SRCLR} = SER = V_{IH}$; SRCLK = RCLK = 9 low to high transitions to configure the outputs to a high level.
 - Guaranteed but not tested.
 - Measurements shall be performed as a go-no-go test on a 100% basis. Read and record measurements shall be performed on a sample of 5 components.

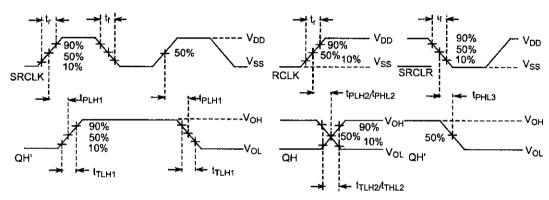
The pulse generator shall have the following characteristics:

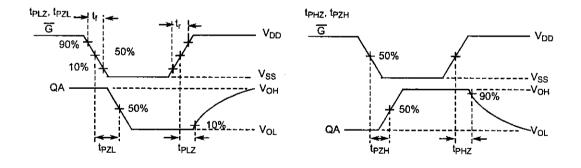
 V_{GEN} = 0 to V_{DD} ; f = 1 MHz minimum; t_r and $t_f \le 6$ ns (10% to 90%); duty cycle = 50%; Z_{out} = 50Ω Output load capacitance C_L = 50pF ± 5% including scope probe, wiring and stray capacitance without component in the test fixture and output load resistance R_L = 1k Ω ± 5%. Propagation delay and transition time shall be measured as follows:

PARAMETER	R_{L}	CL	S1	S2
t _{PZH}	1 kΩ	50pF	OPEN	CLOSED
t _{PZL}			CLOSED	OPEN
t _{PHZ}	1 kΩ	50pF	OPEN	CLOSED
t _{PLZ}			CLOSED	OPEN
t _{PHL} ,t _{PLH} , t _{THL} , t _{TLH}	-	50pF	OPEN	OPEN









- 6. Read and record measurements shall be made on a sample of 5 components, with O failurs permitted.
- 7. A pulse, having the following conditions, shall be applied to the cleck inputs: $V_P = 0V$ to V_{DD} We.

Maximum Clock frequency (CSK) requirement shall be considered as met if proper output state changes occur with the pulse repetition rate set to that given in the "Limits" column.

Limits



2.4 PARAMETER DRIFT VALUES

Unless otherwise specified, the measurements shall be performed at T_{amb} =+22±3°C.

The test methods and test conditions shall be as per the corresponding test defined in Electrical Measurements at Room Temperature, Electrical Measurements.

The drift values (Δ) shall not be exceeded for each characteristic specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

Characteristics	Symbols		Units		
		Drift	Abs	olute	
		Value Δ	Min	Max	
Quiescent Current	I _{DD}	±120	-	400	nA
Low Level Input Current	I _{IL}	±20	-	-50	nA
High Level Input Current	I _{IH}	±20	-	50	пA
Low Level Output Voltage 4	V _{OL4}	±26	-	260	mV
High Level Output Voltage 4	V _{OH4}	±0.2	3.98	-	V
Threshold Voltage N-Channel	V _{THN}	±0.3	-0.45	-1.45	V
Threshold Voltage P-Channel	V _{THP}	±0.3	0.45	1.35	V

, V_{он}6

NOTES:

Unless otherwise specified all inputs and outputs shall be tested for each characteristic.

2.5 <u>INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS</u>

Unless otherwise specified, the measurements shall be performed at T_{amb} =+22 \pm 3°C.

The test methods and test conditions shall be as per the corresponding test defined in Electrical Measurements at Room Temperature, Electrical Measurements.

The drift values (Δ) shall not be exceeded for each characteristic where specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

LowLevel Output Volkage 6	Vole	±26	_	260	m۷
High Level Output Voltage 6	V _{OH6}	±0.2	3.98	-	V



Characteristics	Symbols		Limits	: :	Units
		Drift Value	Abs	olute	
		Δ	Min	Max	
Functional Test 1	-	-	-	-	-
Functional Test 2		-	-	-	-
Functional Test 3	-	-	-	-	-
Quiescent Current	I _{DD}	±120	-	400	nA
Low Level Input Current	I _{IL}	±20	-	-50	nA
High Level Input Current	I _{IH}	±20	-	50	nA
Low Level Output Voltage 4	V _{OL4}	±26	-	260	mV
Low Level Output Voltage 5	V_{OL5}	±26	-	260	mV
High Level Output Voltage 4	V _{OH4}	±0.2	3.98	-	V
High Level Output Voltage 5	V _{OH5}	±0.2	5.48	-	V
Threshold Voltage N-Channel	V _{THN}	±0.3	-0.45	-1.45	V
Threshold Voltage P-Channel	V _{THP}	±0.3	0.45	1.35	V
Output Leakage Current Third State, Low Level Applied	lozL	±200	-	-500	nA
Output Leakage Current Third State, High Level Applied	l _{ozh}	±200	-	500	nA

VOL6, VOL7 →

NOTES:

Unless otherwise specified all inputs and outputs shall be tested for each characteristic.

The drift values (Δ) are applicable to the Operating Life test only.

Law Level Dutput Voltage 6	VOLG	±26	_	260	m٧
Low Level Ontonk Voltage 7	Vol7	±26	_	260	mV
High Level Onkent Voltrage 6	Vous	±0.2	3.98	-	٧
High Lovel Output Voltage 7	Vou7	±0.2	5.48	1	V



2.6 <u>HIGH TEMPERATURE REVERSE BIAS BURN-IN CONDITIONS</u>

2.6.1 N-Channel HTRB

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T _{amb}	+125 (+0 -5)	°C
Outputs QA, QB, QC, QD, QE, QF, QG, QH, QH'	V _{OUT}	Open or V _{SS}	·v
Inputs SRCLR, SRCLK, RCLK, G, SER	V _{IN}	V _{SS}	V
Positive Supply Voltage	V _{DD}	6 (+0 -0.5)	V
Negative Supply Voltage	V _{SS}	0	V
Duration	t ·	72	Hours

NOTES:

- 1. Input Protection Resistor = 680Ω min to $47k\Omega$ max.
- 2. Output Load = $1k\Omega$ min to $10k\Omega$ max.

2.6.2 P-Channel HTRB

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T _{amb}	+125 (+0 -5)	°C
Outputs QA, QB, QC, QD, QE, QF, QG, QH, QH'	V _{OUT}	Open or V _{DD}	·V
Inputs SRCLR, SRCLK, RCLK, G, SER	V _{IN}	V _{DD}	V
Positive Supply Voltage	V _{DD}	6 (+0 -0.5)	V
Negative Supply Voltage	V _{SS}	0	V
Duration	t	72	Hours

NOTES:

- 1. Input Protection Resistor = 680Ω min to $47k\Omega$ max.
- 2. Output Load = $1k\Omega$ min to $10k\Omega$ max.



2.7 POWER BURN-IN CONDITIONS

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T _{amb}	+125 (+0 -5)	°C
Outputs QA, QB, QC, QD, QE, QF, QG, QH, QH'	V _{OUT}	V _{DD}	V
Inputs SRCLR, SER	V _{IN}	V _{DD}	V
Inputs SRCLK, RCLK	V _{IN}	V _{GEN1}	V
Input G	V _{IN}	V _{GEN2}	V
Pulse Voltage	V _{GEN}	0V to V _{DD}	V
Pulse Frequency Square Wave	f _{GEN1} f _{GEN2}	100k ± 10% 50k ± 10% 50 ± 15% Duty Cycle t _r =t _f ≤400ns	Hz
Positive Supply Voltage	V _{DD}	6 (+0 -0.5)	V
Negative Supply Voltage	V _{SS}	0	V

NOTES:

- 1. Input Protection Resistor = 680Ω min to $47k\Omega$ max.
- 2. Output Load = $1k\Omega$ min to $10k\Omega$ max.

2.8	OPERATING LIFE CONDITIONS
	The conditions shall be as specified for power burn-in

2.9 TOTAL DOSE RADIATION TESTING

2.9.1 Bias Conditions and Total Dose Level for Total Dose Radiation Testing

Continuous bias shall be applied during irradiation testing as specified below.

The total dose level applied shall be as specified in the component type variant information herein or in the purchase order.



haracteristics Symbols		Test Conditions	Units	
Ambient Temperature	T _{amb}	+ 22 ± 3	°C	
Outputs QA, QB, QC, QD, QE, QF, QG, QH, QH'	V _{OUT}	Open	('V	
Inputs SRCLR, G	V _{IN}	V _{SS}	V	
Inputs SRCLK, RCLK, SER	V _{IN}	V_{DD}	V	
Positive Supply Voltage	V _{DD}	6 ± 0.3	V	
Negative Supply Voltage	V _{SS}	0	V	

NOTES:

2.9.2 <u>Electrical Measurements for Total Dose Radiation Testing</u>

Prior to irradiation testing the devices shall have successfully met Room Temperature Electrical Measurements specified herein.

Unless otherwise stated the measurements shall be performed at T_{amb} = +22 ± 3 °C. The test methods and test conditions shall be as per the corresponding test defined in Electrical Measurements at Room Temperature, Electrical Measurements.

The parameters to be measured during and on completion of irradiation testing are shown below.

Unless otherwise specified all inputs and outputs shall be tested for each characteristic.

Characteristics	Symbols	Limits			Units
		Drift Absolute		olute	-
		Values Δ	Min	Max	
Quiescent Current	I _{DD}	-	-	40	μA
Threshold Voltage N-Channel	V _{THN}	±0.6	-0.4	-1.5	V
Threshold Voltage P-Channel	V _{THP}	±0.6	0.4	1.4	V

^{1.} Input Protection Resistor = 680Ω min to $47k\Omega$ max.



APPENDIX 'A'

AGREED DEVIATIONS FOR STMICROELECTRONICS (F)

ITEMO AFFECTED	
ITEMS AFFECTED	DESCRIPTION OF DEVIATIONS
Deviations from Screening Tests - Chart F3	External Visual Inspection: The criteria applicable to chip out are those described in MIL-STD-883, Test Method 2009, Paras 3.3.6(b) and 3.3.7(a).
	High Temperature Reverse Bias Burn-in: The temperature limits of MIL-STD-883, Para. 4.5.8(c) may be used.
	Power Burn-in test is performed using STMicroelectronics Specification Ref: 0019255.
Deviations from Qualification and Periodic Tests - Chart	External Visual Inspection: The criteria applicable to chip out are those described in MIL-STD-883, Test Method 2009, Paras 3.3.6(b) and 3.3.7(a).
F4	Operating Life: The temperature limits of MIL-STD-883, Para. 4.5.8(c) may be used.
Deviations from Electrical Measuremente et High	Electrical Measurements at High and Low Temperatures may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes High and Low Temperature Electrical
and Low Temperatures	Measurements per the detail specification.
Measurene	A summary of the pilot lot testing shall be provided if required by the burchase oder.
Deviations from Room Temperature Electrical Measurements	All AC characteristics (Capacitance and Timings) may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes AC characteristic measurements per the detail specification.
	A summary of the pilot lot testing shall be provided if required by the burchase order.